

32GB DDR4 Modules from G.Skill

Written by Alice Marshall
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G.Skill adds high-capacity, high-performance specifications based on 32GB modules to a number of memory series, available in dual- and quad-channel kits offering data transfer rates from 2666MT/s to 4000MT/s.



Memory series getting the 32GB modules include the Trident Z Royal DDR4-3200 CL16 256GB (32GBx8), Trident Z Royal DDR4-4000 CL18 128GB (32GBx4), Trident Z Neo DDR4-3600 CL18 128GB (32GBx4), and Trident Z Neo DDR4-3800 C18 64GB (32GBx2). Based on pre-binned 16Gb chips and proprietary PCBs, the lower-end modules are available as single pieces while the higher-end options are available as dual- and quad-channel kits for high-end desktops and workstations.

The UDIMMs feature an XMP 2.0 SDP for setting speeds beyond JEDEC. The highest-performing kits for AMD Ryzen 3000-based PCs are the 64GB DDR4-3800 CL18 and the 128GB DDR4-3600 CL18. Intel users get the 128GB DDR4-4000 CL18 and the 256GB DDR4-3200 CL16. Currently AMD validation involves the MSI MEG X570 Godlike motherboard, whereas Intel validation is on the ASUS ROG Rampage VI Extreme Encore motherboard.

The enthusiast-class G.Skill 32GB unbuffered DIMMs feature aluminium heat spreaders with an RGB lightbar with multiple lighting zones. The Trident Z Royal kits have polished silver or gold heat spreaders and a crystalline RGB lightbar, while the Trident Z Neo feature matte heat spreaders and an RGB lightbar.

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All the above mentioned G.Skill memory kits ship on Q3 2019.

Go [G.Skill Releases New DDR4 32GB Module Specs with Memory Kits Up to 256GB](#)